### 查询FDN306P供应商

AIRCHIL SEMICONDUCTOR®

**FDN306P** 

**General Description** 

### 捷多邦,专业PCB打样工厂,24小时加急出货

FDN306P

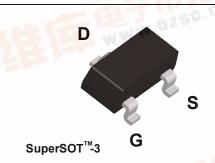


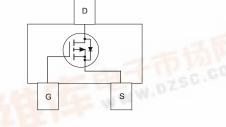
#### This P-Channel 1.8V specified MOSFET uses Fairchild's advanced low voltage PowerTrench process. It has been optimized for battery power management applications.

### Applications

- Battery management
- Load switch
- Battery protection

- -2.6 A, -12 V.  $R_{DS(ON)}$  = 40 m $\Omega$  @ V<sub>GS</sub> = -4.5 V  $R_{DS(ON)}$  = 50 m $\Omega$  @ V<sub>GS</sub> = -2.5 V  $R_{DS(ON)}$  = 80 m $\Omega$  @ V<sub>GS</sub> = -1.8 V
- Fast switching speed
- High performance trench technology for extremely low R<sub>DS(ON)</sub>
- SuperSOT<sup>™</sup> -3 provides low R<sub>DS(ON)</sub> and 30% higher power handling capability than SOT23 in the same footprint





### Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		-12	V
V <sub>GSS</sub>	Gate-Source Voltage		±8	V
ID	Drain Current – Continuous	(Note 1a)	-2.6	A
	- Pulsed		-10	TTOY
P <sub>D</sub>	Maximum Power Dissipation	(Note 1a)	0.5	W
		(Note 1b)	0.46	0
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		- <mark>55 to</mark> +150	°C
Therma	I Characteristics	500		
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	250	°C/W
R <sub>eJC</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	75	°C/W

### Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
306	FDN306P	7"	8mm	3000 units



Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_{D} = -250 \mu A$	-12			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D$ = –250 µA,Referenced to 25°C		-3		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -10 V$ , $V_{GS} = 0 V$			-1	μA
I <sub>GSSF</sub>	Gate–Body Leakage, Forward	$V_{GS} = 8 V$ , $V_{DS} = 0 V$			100	nA
	Gate-Body Leakage, Reverse	$V_{GS} = -8 V$ , $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-0.4	-0.6	-1.5	V
<u>ΔVgs(th)</u> ΔT <sub>J</sub>	Gate Threshold Voltage Temperature Coefficient	$I_D$ = –250 µA,Referenced to 25°C		2.5		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -4.5 \ V,  I_D = -2.6 \ A \\ V_{GS} = -2.5 \ V,  I_D = -2.3 \ A \\ V_{GS} = -1.8 \ V,  I_D = -1.8 \ A \\ V_{GS} = -4.5 \ V, \ I_D = -2.6 \ A, \ T_J = 125^\circ C \end{array} $		30 39 54 40	40 50 80 54	mΩ
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = -4.5 V$ , $V_{DS} = -5 V$	-10			Α
<b>g</b> fs	Forward Transconductance	$V_{DS} = -5 V$ , $I_D = -2.6 A$		10		S
Dvnamio	Characteristics	•				
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -6 V$ , $V_{GS} = 0 V$ ,		1138		pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		454		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			302		pF
Switchir	ng Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = -6 V$ , $I_D = -1 A$ ,		11	20	ns
tr	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V},  R_{GEN} = 6 \Omega$		10	20	ns
t <sub>d(off)</sub>	Turn–Off Delay Time			38	61	ns
t <sub>f</sub>	Turn–Off Fall Time			35	56	ns
Qg	Total Gate Charge	$V_{DS} = -6 V$ , $I_D = -2.6 A$ ,		12	17	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = -4.5 V$		2		nC
Q <sub>gd</sub>	Gate–Drain Charge			3		nC
Drain–S	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain-Sourc				-0.42	Α
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$ , $I_{S} = -0.42$ (Note 2)		-0.6	-1.2	V

# FDN306P



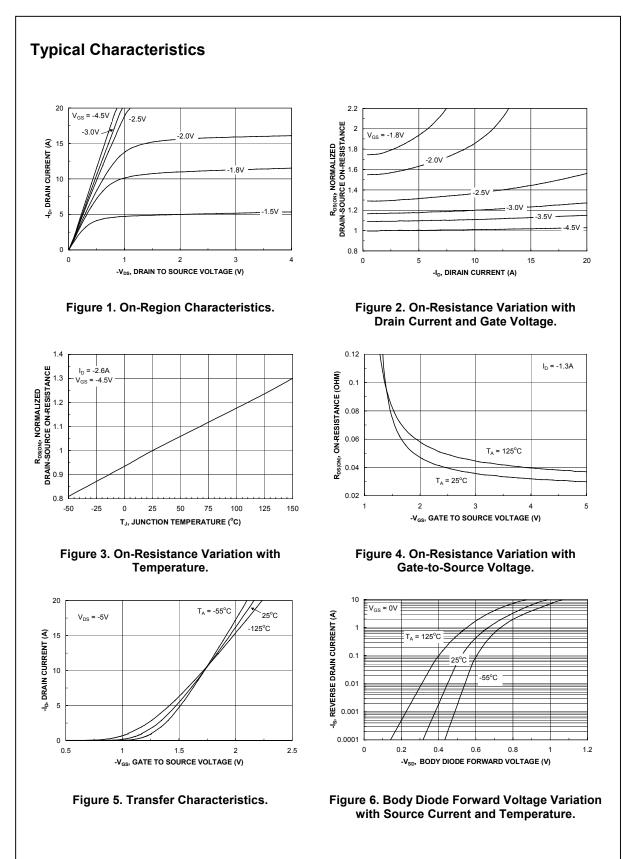
a) 250°C/W when mounted on a 0.02 in<sup>2</sup> pad of 2 oz. copper.



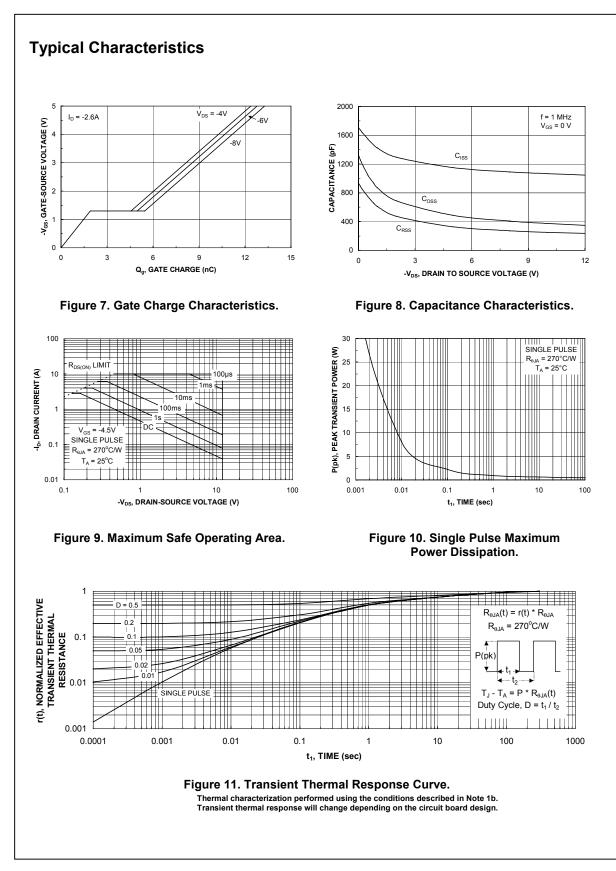
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%

b) 270°C/W when mounted on a minimum pad.



### FDN306P



## FDN306P

TRADEMARKS				
8 8	ed and unregistered tradema austive list of all such trader	arks Fairchild Semiconductor on marks.	owns or is authorized to us	se and is
ACEx <sup>™</sup> Bottomless <sup>™</sup> CoolFET <sup>™</sup> <i>CROSSVOLT</i> <sup>™</sup> DenseTrench <sup>™</sup> DOME <sup>™</sup> EcoSPARK <sup>™</sup> E <sup>2</sup> CMOS <sup>™</sup> EnSigna <sup>™</sup> FACT <sup>™</sup> FACT Quiet Series <sup>™</sup>	FAST <sup>®</sup> FASTr <sup>™</sup> FRFET <sup>™</sup> GlobalOptoisolator <sup>™</sup> GTO <sup>™</sup> HiSeC <sup>™</sup> ISOPLANAR <sup>™</sup> LittleFET <sup>™</sup> MicroFET <sup>™</sup> MicroPak <sup>™</sup> MICROWIRE <sup>™</sup>	OPTOLOGIC <sup>™</sup> OPTOPLANAR <sup>™</sup> PACMAN <sup>™</sup> POP <sup>™</sup> Power247 <sup>™</sup> PowerTrench <sup>®</sup> QFET <sup>™</sup> QS <sup>™</sup> QT Optoelectronics <sup>™</sup> Quiet Series <sup>™</sup> SILENT SWITCHER <sup>®</sup>	SMART START <sup>™</sup> STAR*POWER <sup>™</sup> SuperSOT <sup>™</sup> -3 SuperSOT <sup>™</sup> -6 SuperSOT <sup>™</sup> -8 SyncFET <sup>™</sup> TinyLogic <sup>™</sup> TruTranslation <sup>™</sup> UHC <sup>™</sup> UltraFET <sup>®</sup>	VCX™

STAR\*POWER is used under license

### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

### **PRODUCT STATUS DEFINITIONS**

#### Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.